



HONG KONG ELECTRONICS SYMPOSIUM 2026

**“THE NEXT GENERATION OF AI:
POWERING MOBILITY AND INNOVATION”**

VENUE

Grand Ballroom, Royal Plaza Hotel, Mongkok

DATE

11 May, 2026 (Mon)

TIME

9:00AM – 5:00PM

FEE

MEMBER

NON -

MEMBER

EARLY BIRD

on or before
24 April, 2026

HK\$800

HK\$1000

STANDARD

HK\$1300

HK\$1500

Join us at the Hong Kong Electronics Symposium 2026 to explore “The Next Generation of AI: Powering Mobility and Innovation.” We will gather leading experts from Chinese Mainland and overseas to share insights on how AI is transforming transportation, smart infrastructure, and industrial systems—an excellent opportunity to connect, learn, and be part of the future of intelligent innovation. This year’s program will highlight emerging applications that are reshaping global mobility trends. Attendees can also engage with innovators driving forward next-generation sustainable and smart technologies.

REGISTRATION



HKIE
THE HONG KONG INSTITUTION OF ENGINEERS
香港工程師學會

ELECTRONICS DIVISION
電 子 分 部

STEERING COMMITTEE

Ir Alice Chow
President, HKIE

Ir Prof. Alfred Sit, GBS, JP
Chief Executive and Secretary, HKIE

Ir LH Tse
Executive Member, HKIE
Immediate Past Chairman, HKIE END

Ir Prof. Alan Lam, JP
Chairman of Sengital Group,
CEO of Gravity Capital Partners
Adjunct Professor of CityUHK, CUHK, PolyU

Mr. Simon Wong
Chief Executive Officer
Logistics and Supply Chain MultiTech
R&D Centre (LSCM)

Ir Dr. John Chan
Advisor/Past Chairman, HKIE END

Ir Dr. Wilton Fok
Advisor/Past Chairman, HKIE END

Ir Prof. Frank Chan, GBS, JP
Senior Vice President, HKIE

Ir Wilson Kwok
Executive Member, HKIE
Advisor/Past Chairman, HKIE END

Ir Prof. KF Tsang
Council Member (Division), HKIE
Advisor/Past Chairman, HKIE END

Ir Victor Ng
Honorary Chairman
Hong Kong Electronics &
Technologies Association

Ir Albert CS Leung
Acting Chief Executive Officer & Chief
Technology Officer
eBRAM International Online Dispute
Resolution Centre

Ir CK Lee
Advisor/Past Chairman, HKIE END

ORGANISING COMMITTEE

Chairman

Ir Andy Lam

Vice Chairman

Ir George Chan

Treasurer

Ir WK Shiu

Technical Program

Ir Prof. KF Tsang
Ir Dr. Wilton Fok
Ir Wilson Kwok
Ir Dr. CK Li
Ir Dr. YH Shum
Ir Albert CS Leung

Sponsorship Team

Ir Prof. KF Tsang
Ir Dr. John Chan
Ir Prof. Alan Lam, JP
Mr. Sam Lam
Ms. Yan So

Publicity Team

Ir Alan Chan
Ir Albert Chang
Ir Cheryl Leung
Ms. Carol Chen
Mr. Martin Lam

Logistic Team

Ir Larry Yuen
Ir Henry Au
Ir Ken Chan
Ir Homan Ho
Ir LeeMan Wong

Design & Publication Team

Ir Jheri Wong
Mr. Martin Lam
Mr. Albert PH Leung
Mr. Jacky Liang

Webmaster

Mr. Patrick Dong
Mr. Simon Lee
Mr. Albert PH Leung

Media

Mr. Jim Chim
Mr. Ning Kam
Mr. Stephen Sit

SPONSORS

Gold Sponsors



Silver Sponsors



Sponsor for real-time transcript and translation

Bronze Sponsor



SUPPORTING ORGANISATIONS



數字政策辦公室
Digital Policy Office

機電工程署
EMSD



The Chartered Institute of Logistics and Transport



Department of Electrical Engineering
香港城市大學
City University of Hong Kong



香港工業總會
FHKI



香港資訊科技聯會



Member of VTC Group
VTC 機構成員



香港貿發局



Logistics and Supply Chain MultiTech R&D Centre
物流及供應鏈多元技術研發中心



香港都會大學
科技學院
Hong Kong Metropolitan University
School of Science and Technology



智慧城市聯盟
Smart City Consortium



DEPARTMENT OF ELECTRONIC & COMPUTER ENGINEERING



Department of Electrical and Electronic Engineering
電機電子工程系



Hong Kong Electronics Symposium 2026

Theme: The Next Generation of AI - Powering Mobility and Innovation

11 May 2026, Grand Ballroom, Royal Plaza Hotel, Mongkok

PRELIMINARY PROGRAMME

Time	Activity	Speaker / Moderator
08:30 – 09:00	Registration	
09:00	Welcome Speech	Ir Dr. YH SHUM Chairman, HKIE Electronics Division
	Opening Speech	Ir Prof. Frank Fan CHAN, JP, OB Senior Vice President, HKIE
	Award Presentation for Hong Kong Electronics Project Competition 2026 (HKEPC2026)	
	Keynote Speech Accelerating AI and Digital Economy Development in Hong Kong	Mr. Daniel CHEUNG, JP Acting Commissioner for Digital Policy Digital Policy Office Hong Kong SAR Government
	Group Photo	
	Address from GuangDong Institute of Electronics	Prof. Cairong ZOU Chairman GuangDong Institute of Electronics
	Talk 1 Empowering by AI+: Challenges in the New Tech Era	Ir Prof. Hon William Kam-fai WONG Vice Chairman & Secretary General, HK Alliance of Technology and Innovation Advisor, Our Hong Kong Foundation Legislative Councillor
10:40	Tea Break	
	Talk 2 Co-GenAI: A Novel Fusion-Driven Framework	Prof. Hongxia YANG Associate Dean of the Faculty of Computing and Mathematical Sciences and Executive Director of the PolyU Academy Hong Kong Polytechnic University
	Talk 3 A Global-Oriented Standards Framework work for the Low-Altitudes Economy	Prof. Chitin HON Department of Engineering and Science, Faculty of Innovation Engineering Macau University of Science and Technology
	Panel Discussion (Morning) Standardization and Current Development of AI	<u>Facilitator</u> Ir Prof. Kim-fung TSANG Council Member, HKIE Past Chairman, HKIE Electronics Division <u>Panelists</u> Hon Duncan CHIU, MH Legislative Councillor Prof. Chitin HON Department of Engineering and Science, Faculty of Innovation Engineering Macau University of Science and Technology Ir Prof. Hon William Kam-fai WONG Vice Chairman & Secretary General, HK Alliance of Technology and Innovation Advisor, Our Hong Kong Foundation Legislative Councillor Prof. Hongxia YANG Associate Dean of the Faculty of Computing and Mathematical Sciences and Executive Director of the PolyU Academy Hong Kong Polytechnic University
	Group photo & souvenir presentation	

Hong Kong Electronics Symposium 2026

Time	Activity	Speaker / Moderator
12:40	Lunch	
14:00	Keynote Speech	Ir Vincent CHOW, JP Acting Director Electrical and Mechanical Services Department Hong Kong SAR Government
	Talk 4 From Data to Movement: AI for the Next Generation of Smart Micro-Mobility	Mr. Steve NG General Manager and Chief Research Officer LocoBike
	Talk 5 AI-Powered Mobile Traffic Control and Surveillance System for Enhancing Road Safety in Hong Kong	Mr. Eric LEUNG IT Project Manager Autotoll Limited
14:55	Tea Break	
	Talk 6 Hikvision Guanlan AI Large Model: Breaking the Isolation of Vision and Language, Facilitating Digital Transformation in Thousands of Industries	Mr. House ZHU Business Development Manager Hikvision Technology Pte. Ltd.
	Talk 7 Intelligent New Chapter · Smart Hong Kong — Innovative Applications of AI in Digital Governance and Smart City Development	Dr. Peng WANG Vice President of R&D and Chief Architect of Huawei's Government Public Service Digitalization BU Huawei
	Talk 8 Using Physics-based Models and AI for Virtual Manufacturing of Batteries	Dr. Masoud JABBARI Assistant Professor and Deputy Director of Postgraduate Research Assistant Professor, School of Mechanical Engineering, University of Leeds (UK) Visiting Researcher, School of Physics and Engineering, University of York (UK)
	Panel Discussion (Afternoon) Next Generation of AI for Smart Mobility and Sustainable Cities	<p><u>Facilitator</u> Mr. Simon WONG CEO Logistics and Supply Chain MultiTech R&D Centre</p> <p><u>Panelists</u> Mr. Karel AU Chief Executive Officer Autotoll Limited</p> <p>Mr. Ken CHING Chairman LocoBike</p> <p>Dr. Masoud JABBARI Assistant Professor and Deputy Director of Postgraduate Research Assistant Professor, School of Mechanical Engineering, University of Leeds (UK) Visiting Researcher, School of Physics and Engineering, University of York (UK)</p> <p>Ir Timothy WONG Senior Engineer Electrical and Mechanical Services Department Hong Kong SAR Government</p> <p>Dr. Peng WANG Vice President of R&D and Chief Architect of Huawei's Government Public Service Digitalization BU Huawei</p>
	Group photo & souvenir presentation	
	Closing Speech	Ir Andy LAM OC Chairman, HKES 2026 Deputy Chairman, HKIE Electronics Division
17:00	End	

**Programme is subject to change.

Prepared: Veronica Cheng

Date: 08 May 2026